

N-Channel Enhancement MOSFET

Features

- Trench Power LV MOSFET technology
- Voltage Controlled Small Signal Switch
- Halogen-Free & Lead-Free

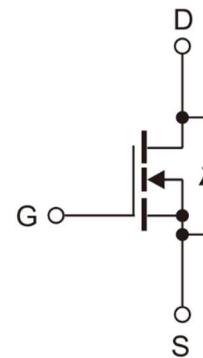
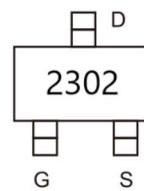
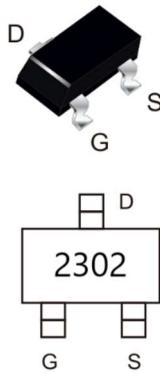
Product Summary			
V _{DS}	R _{D(on)} (mΩ) Typ	I _D (A)	Q _g (Typ)
20V	29 @ 2.5V	4.3	6.6nC
	21 @ 4.5V		

Application

- Load Switch for Portable Devices
- Solid-state relays
- DC/DC Converter

Marking information

SOT-23



N-channel MOSFET

Absolute Maximum Ratings (at T_A = 25°C unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V _{DS}	20	V
Gate-Source Voltage	V _{GS}	±10	V
Continuous drain current (T _A =25 °C)	I _D	4.3	A
Continuous drain current (T _A =70 °C)	I _D	3.5	A
Power Dissipation	P _D	1.0	W
Operating Junction	T _J	-55~150	°C
Storage Temperature Range	T _{stg}	-55~150	°C

Thermal Characteristics

Parameter	Symbol	Max.	Unit
Thermal Resistance from Junction to Ambient ¹⁾	R _{θJA}	125	°C/W

Note:

1. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch.

Characteristics at $T_J = 25^\circ\text{C}$ unless otherwise specified

Parameter	Symbol	Min.	Typ.	Max.	Unit
STATIC PARAMETERS					
Drain-Source Breakdown Voltage at $V_{GS}=0\text{V}$, $I_D=250\mu\text{A}$	BV_{DSS}	20			V
Drain-Source Leakage Current at $V_{DS}=20\text{V}$, $V_{GS}=0\text{V}$	I_{DSS}			1	μA
Gate Leakage Current at $V_{GS}=\pm 10\text{V}$, $V_{DS}=0\text{V}$	I_{GSS}			± 0.1	μA
Gate-Source Threshold Voltage at $V_{DS}=V_{GS}$, $I_D=250\mu\text{A}$	$V_{GS(\text{th})}$	0.55	0.85	1.25	V
Drain-Source On-State Resistance at $V_{GS}=4.5\text{V}$, $I_D=4.3\text{A}$ at $V_{GS}=2.5\text{V}$, $I_D=3.0\text{A}$	$R_{DS(\text{on})}$		21 29	27 37	$\text{m}\Omega$
DYNAMIC PARAMETERS					
Input Capacitance at $V_{DS}=10\text{V}$, $V_{GS}=0\text{V}$, $f=1\text{MHz}$	C_{iss}		595		pF
Output Capacitance at $V_{DS}=10\text{V}$, $V_{GS}=0\text{V}$, $f=1\text{MHz}$	C_{oss}		106		pF
Reverse Transfer Capacitance at $V_{DS}=10\text{V}$, $V_{GS}=0\text{V}$, $f=1\text{MHz}$	C_{rss}		59		pF
Gate charge total at $V_{DS}=10\text{V}$, $V_{GS}=4.5\text{V}$, $I_D=4.3\text{A}$	Q_g		6.6		nC
Gate to Source Charge at $V_{DS}=10\text{V}$, $V_{GS}=4.5\text{V}$, $I_D=4.3\text{A}$	Q_{gs}		0.9		nC
Gate to Drain Charge at $V_{DS}=10\text{V}$, $V_{GS}=4.5\text{V}$, $I_D=4.3\text{A}$	Q_{gd}		1.4		nC
Turn-On Delay Time at $V_{DD}=10\text{V}$, $R_L=1.5\Omega$, $R_{GEN}=3\Omega$, $V_{GS}=4.5\text{V}$	$t_{d(\text{on})}$		13		nS
Turn-On Rise Time at $V_{DD}=10\text{V}$, $R_L=1.5\Omega$, $R_{GEN}=3\Omega$, $V_{GS}=4.5\text{V}$	t_r		54		ns
Turn-Off Delay Time at $V_{DD}=10\text{V}$, $R_L=1.5\Omega$, $R_{GEN}=3\Omega$, $V_{GS}=4.5\text{V}$	$t_{d(\text{off})}$		18		nS
Turn-On Fall Time at $V_{DD}=10\text{V}$, $R_L=1.5\Omega$, $R_{GEN}=3\Omega$, $V_{GS}=4.5\text{V}$	t_f		11		ns
Body-Diode PARAMETERS					
Drain-Source Diode Forward Voltage at $I_s=4.3\text{A}$, $V_{GS}=0\text{V}$	V_{SD}			1.2	V
Maximum Body-Diode Continuous Current	I_s			4.3	A

Electrical Characteristics Curves

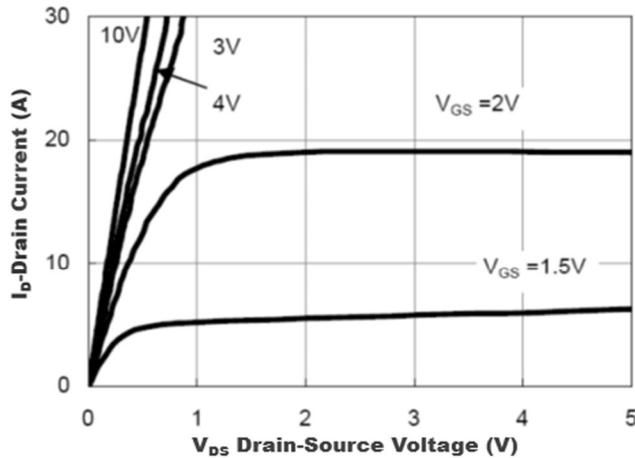


Figure1. Output Characteristics

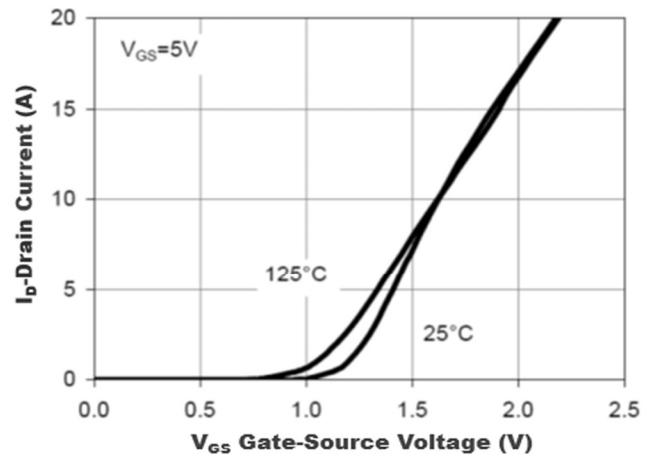


Figure2. Transfer Characteristics

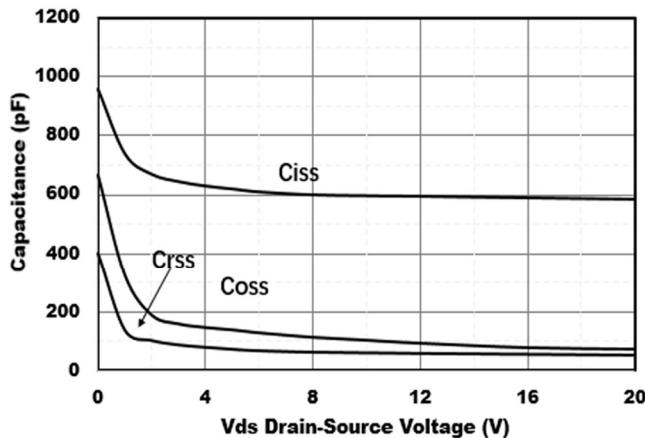


Figure3. Capacitance Characteristics

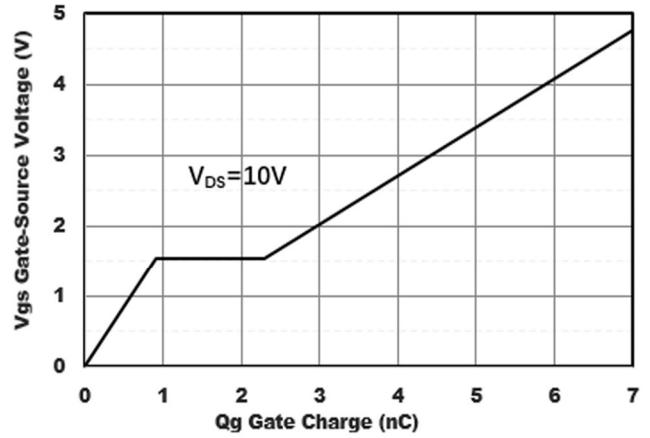


Figure4. Gate Charge

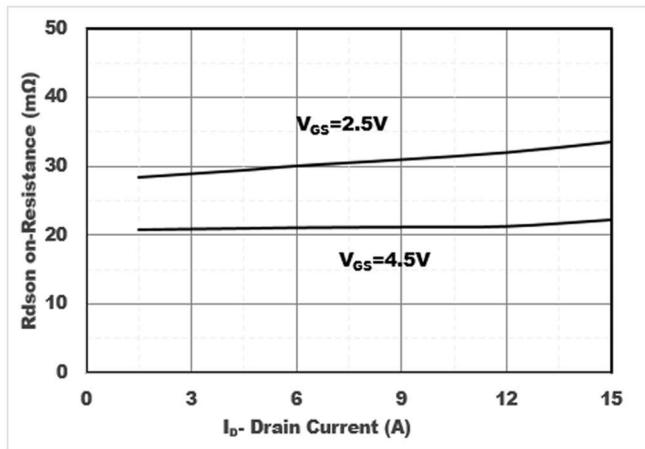


Figure5. Drain-Source on Resistance

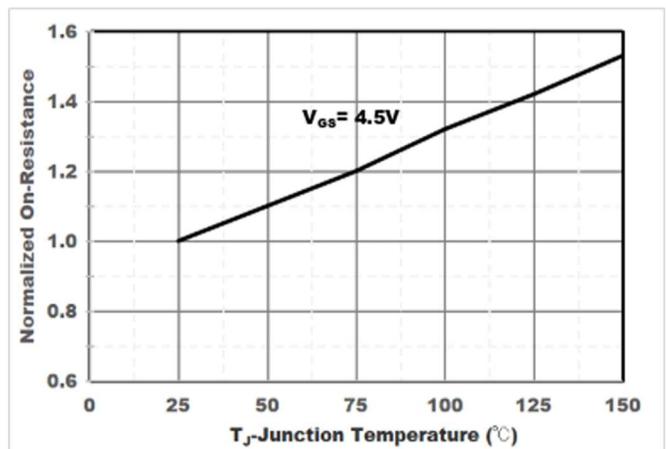


Figure6. Drain-Source on Resistance

Electrical Characteristics Curves

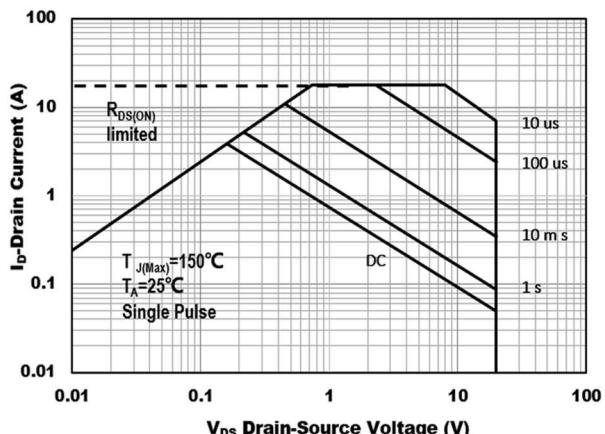


Figure7. Safe Operation Area

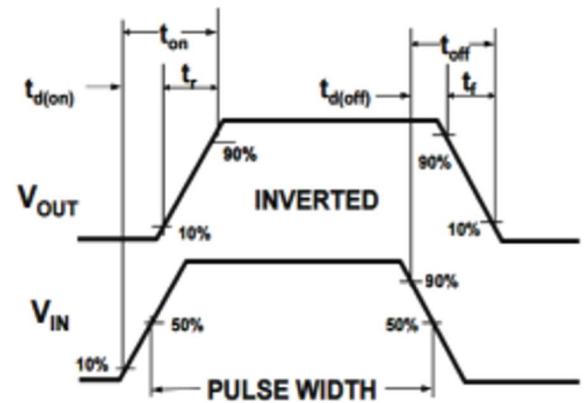
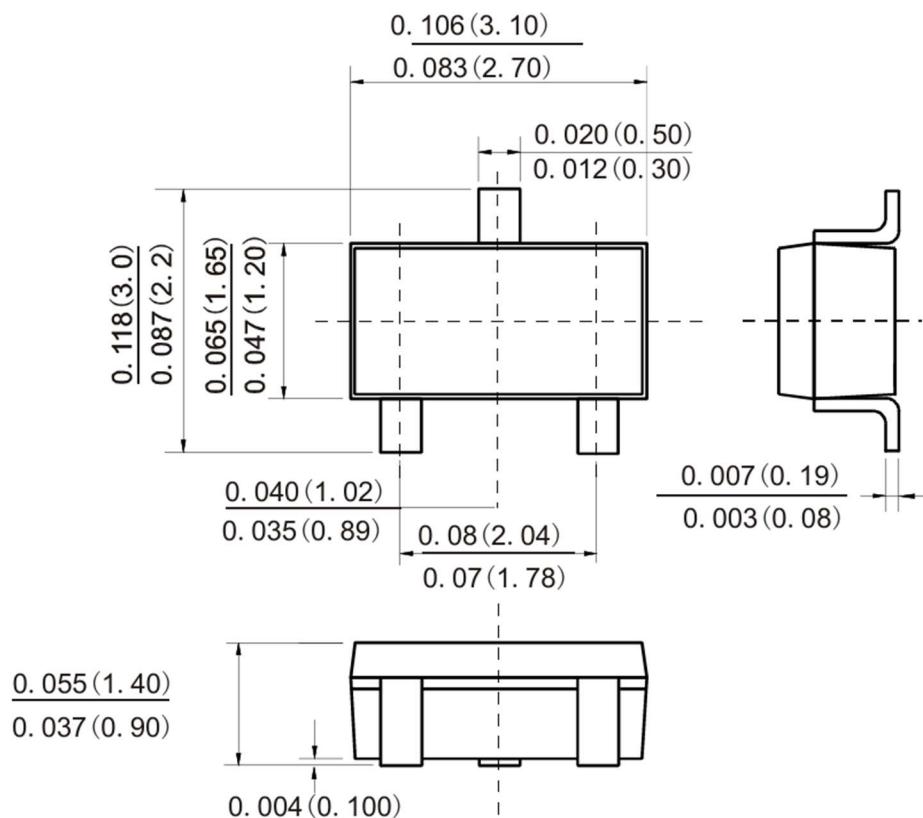
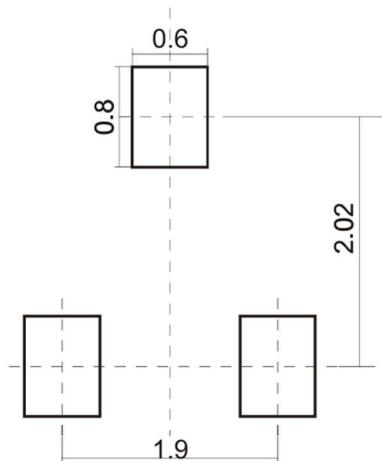


Figure8. Switching wave

Package Outline Dimensions (Units: mm) SOT-23



Dimensions in inches and (millimeters)

Suggested Pad Layout

Dimensions in millimetres

Order Information

Part Number	Package	Quantity
Sh2302A	SOT-23	3000